



RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE

IN THE U.S. PATENT AND TRADEMARK OFFICE

November 27, 2007

Applicants: Tetsuo NISHIKAWA et al

For: THERMOPLASTIC RESIN COMPOSITION

Serial No.: 09/973 646 Group: 1714

Confirmation No.: 6210

Filed: October 9, 2001 Examiner: Shosho

Atty. Docket No.: Nanjo 1

Mail Stop AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

*OIC to Enter  
E.C. 12/07*

**AMENDMENT AFTER FINAL REJECTION**

Sir:

In response to the Office Action dated September 7, 2007,  
please amend the above-identified application as follows:

(Please see following pages.)

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being  
deposited with the United States Postal Service with  
sufficient postage as first class mail in an envelope  
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Alexandria, VA 22313-1450, on November 27, 2007.

  
Terryence F. Chapman

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